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DATA SHEET

BFQ161
NPN video transistor

Product specification
Supersedes data of November 1995
File under Discrete Semiconductors, SC05

1997 Oct 02

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NPN video transistor BFQ161

FEATURES

- Low output capacitance
- High gain bandwidth
- High current applicability
- Good thermal stability
- Gold metallization ensures excellent reliability.

APPLICATIONS

- Pre-stage driver in high resolution colour graphics monitors.

DESCRIPTION

NPN video transistor in a SOT54 (TO-92) plastic package.

PINNING

PIN	DESCRIPTION
1	base
2	collector
3	emitter

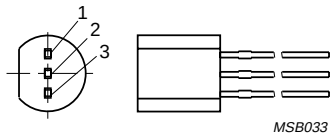


Fig.1 Simplified outline (SOT54; TO-92).

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	20	V
V_{CER}	collector-emitter voltage	R_{BE} = 100 Ω	–	19	V
I_C	collector current (DC)		–	500	mA
P_{tot}	total power dissipation	$T_s \leq 75$ °C; note 1	–	1	W
h_{FE}	DC current gain	I_C = 300 mA; V_{CE} = 5 V	25	–	
f_T	transition frequency	I_C = 300 mA; V_{CE} = 5 V; T_{amb} = 25 °C	1	–	GHz
T_j	junction temperature		–	150	°C

Note

1. T_s is the temperature at the soldering point of the collector pin, 4 mm from the body.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	20	V
V_{CEO}	collector-emitter voltage	open base	–	10	V
V_{CER}	collector-emitter voltage	R_{BE} = 100 Ω	–	19	V
V_{EBO}	emitter-base voltage	open collector	–	3	V
I_C	collector current (DC)		–	500	mA
P_{tot}	total power dissipation	$T_s \leq 75$ °C; notes 1 and 2; see Fig.3	–	1	W
T_{stg}	storage temperature range		–65	+150	°C
T_j	junction temperature		–	150	°C

Notes

1. T_s is the temperature at the soldering point of the collector pin, 4 mm from the body.
2. Transistor mounted on a printed-circuit board with a metallized pad area of 10 mm^2.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j\text{-}s}$	thermal resistance from junction to soldering point	note 1	75	K/W
$R_{th\ j\text{-}a}$	thermal resistance from junction to ambient		175	K/W
$R_{th\ s\text{-}a}$	thermal resistance from soldering point to ambient		100	K/W

Note

1. T_s is the temperature at the soldering point of the collector pin, 4 mm from the body.

CHARACTERISTICS

T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)CBO}$	collector-base breakdown voltage	I_C = 5 mA; I_E = 0	20	–	–	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	I_C = 10 mA; I_B = 0	10	–	–	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	I_E = 0.1 mA; I_C = 0	3	–	–	V
I_{CES}	collector-emitter cut-off current	I_B = 0; V_{CE} = 10 V	–	–	100	μA
h_{FE}	DC current gain	I_C = 300 mA; V_{CE} = 5 V; T_{amb} = 25 °C; see Fig.4	25	–	–	
		I_C = 100 mA; V_{CE} = 5 V; T_{amb} = 25 °C; see Fig.4	40	50	–	
C_{cb}	collector-base capacitance	I_C = 0; V_{CB} = 5 V; f = 1 MHz; see Fig.5	–	4.3	–	pF
C_c	collector capacitance	$I_E = i_e$ = 0; V_{CB} = 5 V; f = 1 MHz	–	6	–	pF
f_T	transition frequency	I_C = 300 mA; V_{CE} = 5 V; see Fig.6	1	–	–	GHz

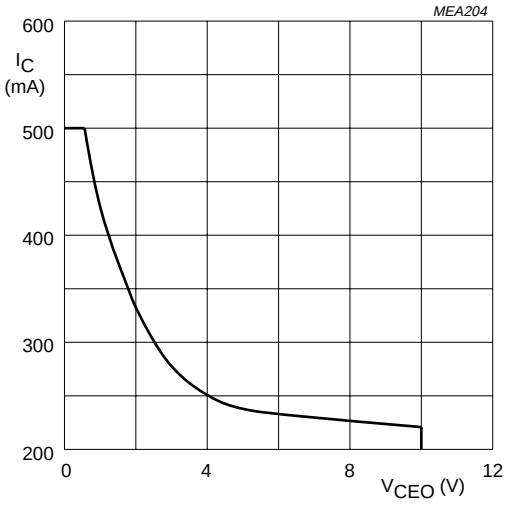


Fig.2 DC SOAR.

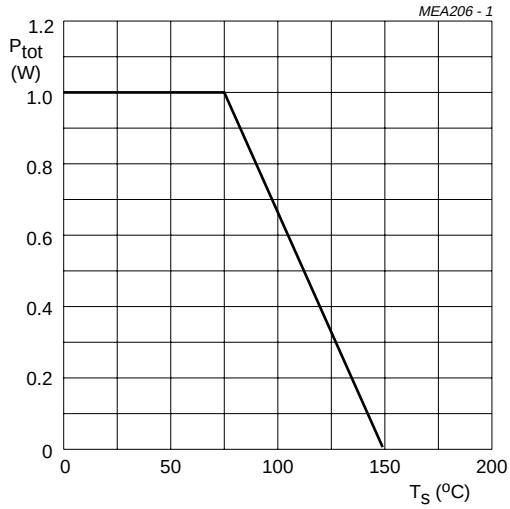
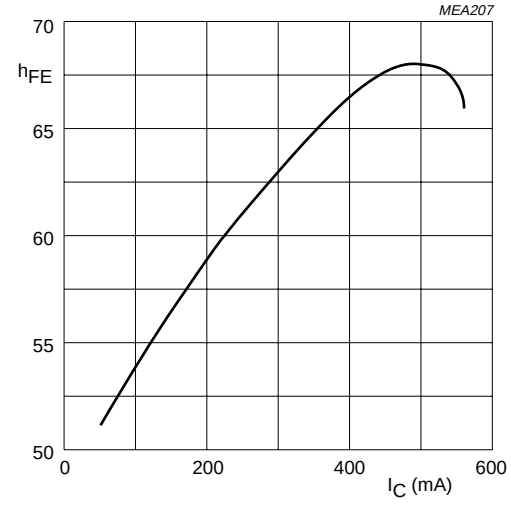
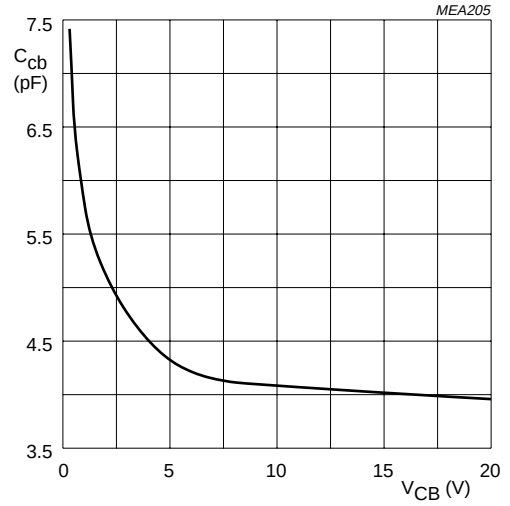


Fig.3 Power derating curve.



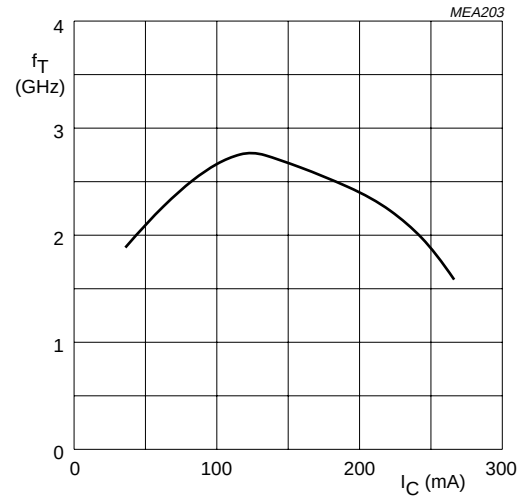
V_{CE} = 5 V; T_{amb} = 25 °C.

Fig.4 DC current gain as a function of collector current; typical values.



f = 1 MHz; T_{amb} = 25 °C.

Fig.5 Collector-base capacitance as a function of collector-base voltage; typical values.

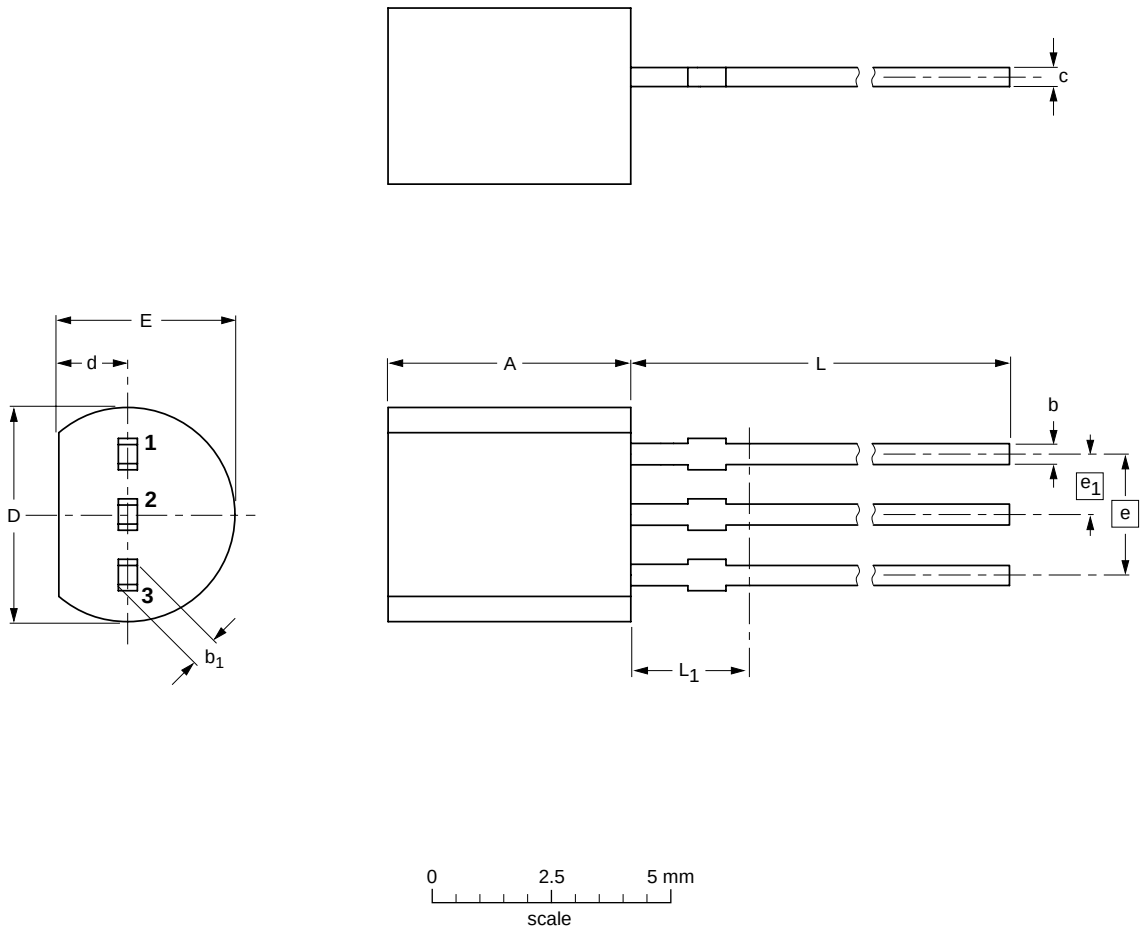


V_{CE} = 5 V; T_{amb} = 25 °C.

Fig.6 Transition frequency as a function of collector current; typical values.

PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads **SOT54**



DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b_1	c	D	d	E	e	e_1	L	L_1(1)
mm	5.2 5.0	0.48 0.40	0.66 0.56	0.45 0.40	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT54		TO-92	SC-43			97-02-28

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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